



1 CHANNEL UNIDIRECTIONAL TVS

Product Summary

V _{BR} Min	I _{PP} Max	C _T Typ
13.3V	13A	80pF

Description

This new generation TVS is designed to protect sensitive electronics from damage due to ESD. The combination of small-size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripherals

Features

- Low Profile Package (0.53mm Max) and Ultra-Small PCB Footprint Area (1.1mm x 0.7mm Max) Suitable for Compact Portable Electronics
- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- One Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.
- https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: X1-DFN1006-2 with Sidewall Plating
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 e4
- Weight: 0.001 grams (Approximate)

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Bottom View

Device Schematic

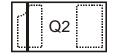
Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D12V0H1U2LP-7B	Standard	Q2	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



Q2 = Product Type Marking Code Bar Denotes Pin 1 or Cathode Side



Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_PP	300	W	8/20µs, per Figure 3
Peak Pulse Current	I _{PP}	13	Α	8/20µs, per Figure 3
ESD Protection—Contact Discharge	V _{ESD_CONTACT}	±30	kV	IEC 61000-4-2 Standard
ESD Protection—Air Discharge	V _{ESD_AIR}	±30	kV	IEC 61000-4-2 Standard

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{OJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

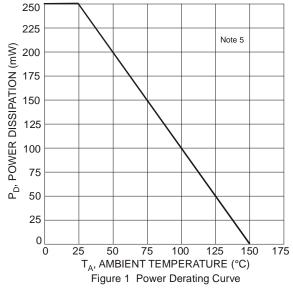
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V_{RWM}	_	_	12.0	V	_
Reverse Current (Note 6)	I _R	_	2	50	nA	$V_R = V_{RWM} = 12.0V$
Reverse Breakdown Voltage	V_{BR}	13.3	_	15.75	V	I _R = 1mA
Daylera Clamping Voltage	V _{CL}	_	_	19	V	$I_{PP} = 5A$, $t_P = 8/20 \mu s$
Reverse Clamping Voltage		_	_	23		I _{PP} = 13A, t _P = 8/20μs
Capacitance	Ст	-	80	95	pF	$V_R = 0V$, $f = 1MHz$

Notes:

^{5.} Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

^{6.} Short duration pulse test used to minimize self-heating effect.





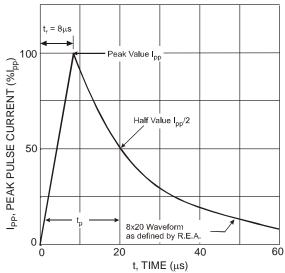
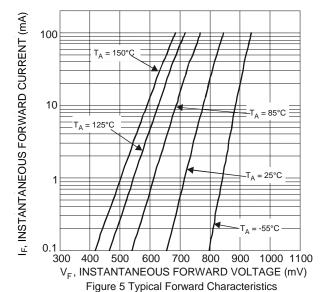
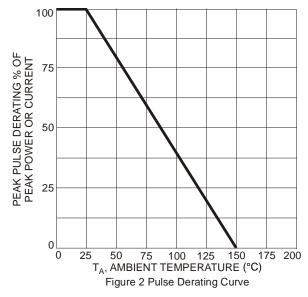
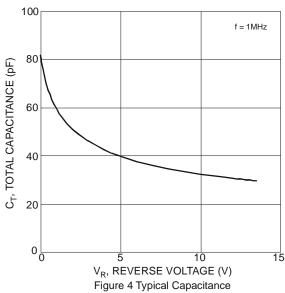
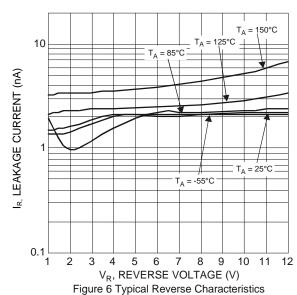


Figure 3 Typical 8 × 20µs Pulse Waveform







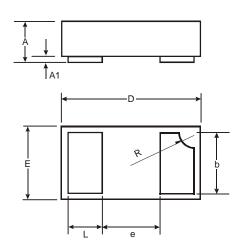




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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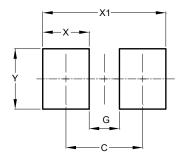


X1-DFN1006-2				
Dim	Min	Max	Тур	
Α	0.47	0.53	0.50	
A1	0	0.05	0.03	
b	0.45	0.55	0.50	
D	0.95	1.075	1.00	
Е	0.55	0.675	0.60	
е	_		0.40	
L	0.20	0.30	0.25	
R	0.05	0.15	0.10	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

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Dimensions	Value (in mm)
С	0.70
G	0.30
Х	0.40
X1	1.10
Υ	0.70



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